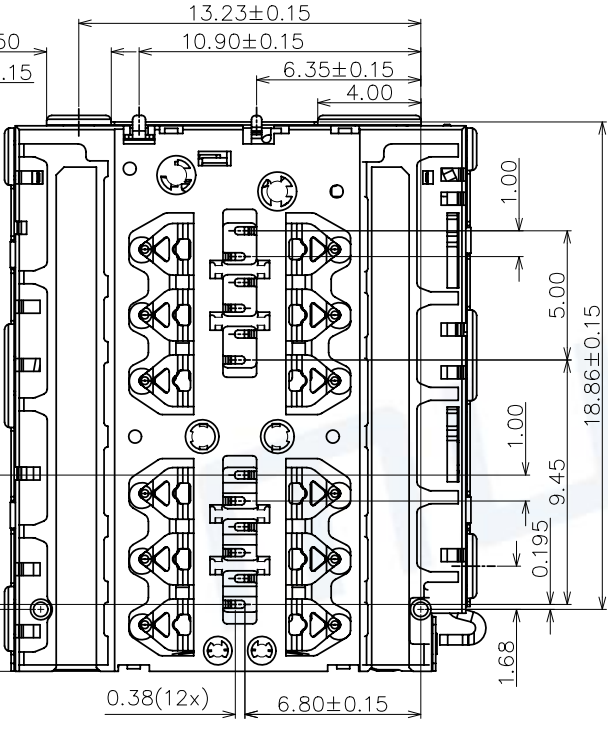
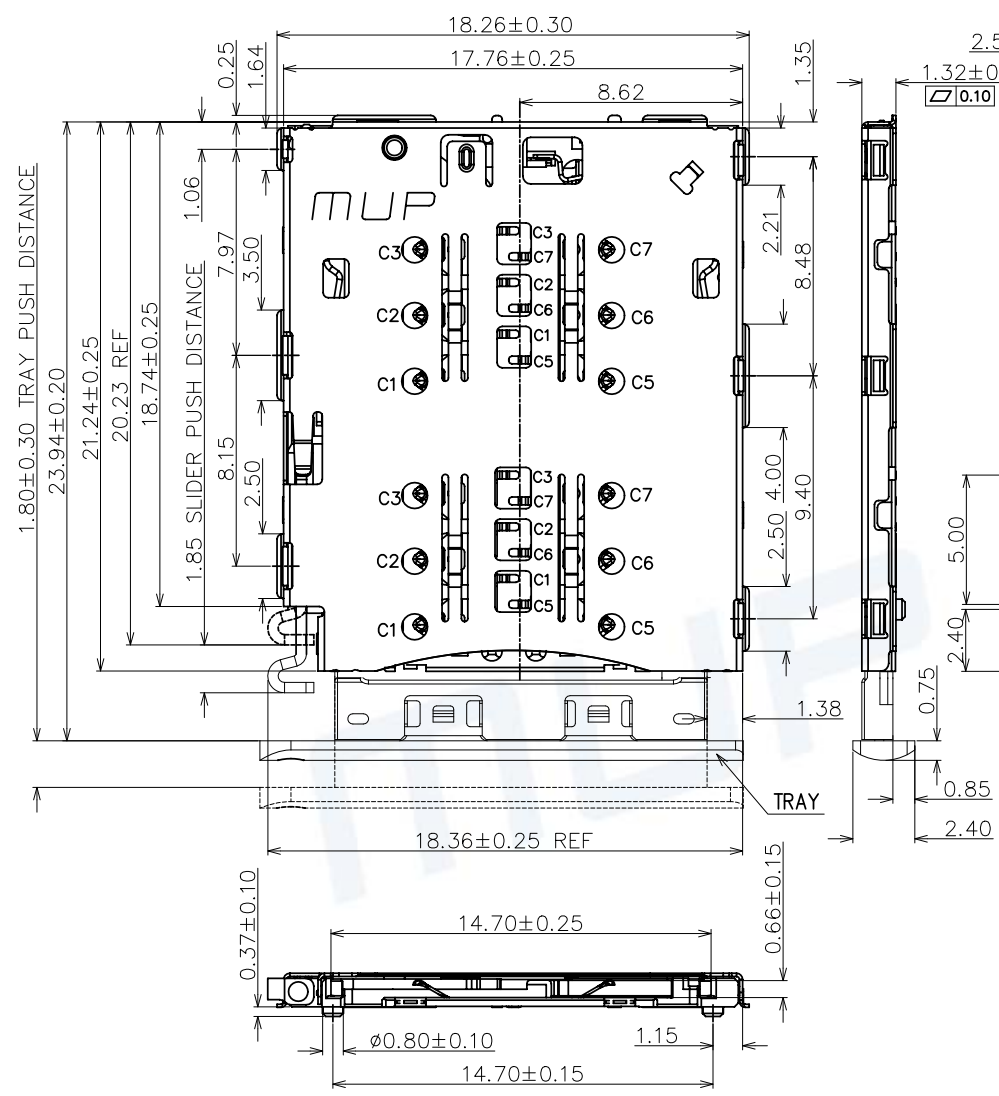


| REV. | DESCRIPTION OF REVISIONS | APPR. | CHKD. | DRAW. | DATE |
|------|--------------------------|-------|-------|-------|------------|
| △ | NEW | | | Henry | 2018/11/22 |
| △ | Original Model C787-1 | | | Henry | 2023/10/19 |



TECHNICAL CHARACTERISTICS

1.General Characteristics
Dimensions:21.24LX17.76WX1.35H mm
TRAY MATING FORCE:1~10N
TRAY UNMATING FORCE:2~10N
Durability:1,500 cycles min.

2.Electrical Characteristics
Contact resistance:50mΩ typical,
100mΩMax
Insulation resistance:>1000MΩ/500V DC

3.Solderability
Vaporphase:215°C, 30sec.Max
IR reflow:250°C,5sec.Max
Manual soldering:370°C,3sec.Max

4.Environmental Characteristics
Operating temperature:-40°C~+85°C
Operating humidity:10%~+95%RH

| ITEM | PART NAME | Q'TY | MATERIAL | FINISH |
|------|--------------|------|-----------------------|--------------------------|
| 1 | HOUSING | 1 | Hi-temp Thermoplastic | Black UL94V-0 |
| 2 | DATA CONTACT | 12 | Copper Alloy | Contact area:Gold plated |
| 3 | SWITCH | 1 | Copper Alloy | Contact area:Gold plated |
| 4 | SHELL | 1 | Stainless Steel | Solder area:Gold plated |
| 5 | RODKER | 1 | Stainless Steel | |
| 6 | LATCH | 2 | Stainless Steel | |
| 7 | LEVER-BAR | 1 | Stainless Steel | |

Unless otherwise specified, other tolerance are:

MUP MUP INDUSTRIAL CO.,LTD.

NAME: **DUAL NANO-SIM Card Connector**

MODEL NO: **MUP-C7087-01**

TYPE : **H1.35mm Normally Colse With Card Tray Type**

| | | | | |
|------------------|------|-------|-------------------|-----------------|
| PROJ. | UNIT | SCALE | DRAWN | DWG NO.: |
| ① | mm | 1:1 | Henry Nov.14.2018 | DWG-C7087-01-01 |
| CUSTOMER DRAWING | | | CHECKED | SHEET |
| | | | Simon Nov.14.2018 | 1/2 |
| | | | APPROVAL | REVISION |
| | | | | 2 |

